

FEATURES

Low profile package

I Ideal for automated placement

Glass passivated Junction chip

High forward surge current capability





APPLICATIONS

For use in general purpose rectification of power supplies,
inverters, converters, and freewheeling diodes for consumer
and telecommunication

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS AND CHARACTERISTICS ($T_A = 25$ °C)

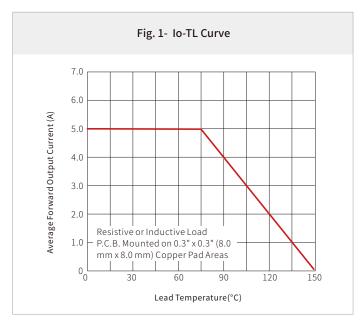
Parameter		Symbol	GS5AB	GS5BB	GS5DB	GS5GB	GS5JB	GS5KB	GS5MB	Unit
Marking			GS5AB	GS5BB	GS5DB	GS5GB	GS5JB	GS5KB	GS5MB	
Maximum Repetitive Peak Reverse Voltage		V _{RRM}	50	100	200	400	600	800	1000	
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000	
Average Rectified Output Current @60Hz Sine Wave, Resistance Load, TL (Fig.1)		I _o	5.0							
Forward Surge Current (Non-Repetitive) @60Hz Half-Sine Wave,1 Cycle, Tj=25°C Forward Surge Current (Non-Repetitive)		I _{FSM}	150 300						А	
@1ms, Square Wave, 1 Cycle, Tj=25°C Maximum Instantaneous Forward Voltage I _{FM} =5.0A		V _F	1.1						V	
Maximum DC Reverse Current at	T _J =25°C		5							μА
Rated DC Blocking Voltage	T _J =125°C	I _R	100							
Typical Junction Capacitance Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C		C	34						pF	
Current Squared Time @1ms≤t≤8.3ms Tj=25°C		l²t	94						A ² s	
Typical Thermal Resistance (1)		$R_{\theta J-A}$				801)				
		$R_{\theta J-L}$				351)				°C/W
		$R_{_{\theta J\text{-}C}}$	301)							
Operating Junction and Storage Temperature Range		$T_{J},\!T_{STG}$			-5	5 to +150)			°C

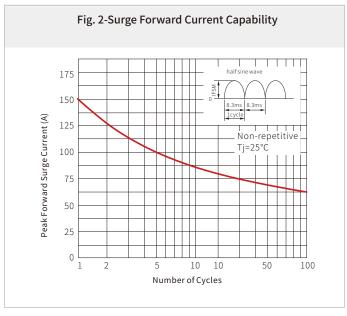
Note:

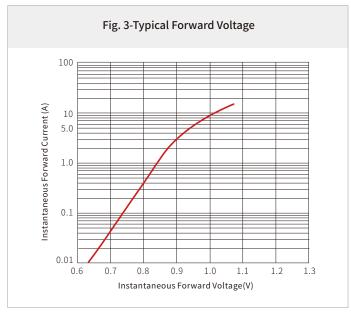
(1) Thermal Resistance From Junction to Ambient and From Junction to Lead Mounted On P.C.B. With 0.3" X 0.3" (8.0 mm X 8.0 mm) Copper Pad Areas

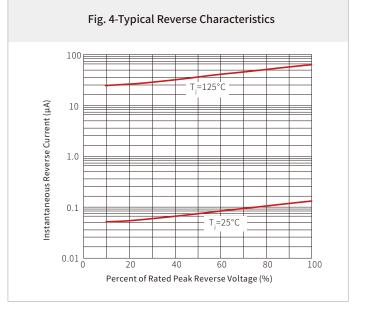


CHARACTERISTIC CURVES





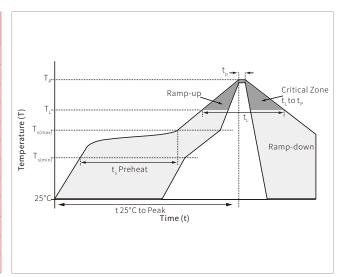




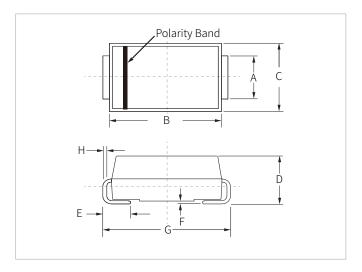


SOLDERING PARAMETERS

	Reflow Condition	Lead-free assembly		
	Temperature Max (T _{s(min)})	150°C		
Pre Heat	Temperature Max (T _{s(max)})	200°C		
	Time (min to max) (t_s)	60 – 180 secs		
Average ran	Average ramp up rate (Liquidus Temp (T _L) to peak			
	3°C/second max			
Reflow	Temperature (T _L) (Liquidus)	217°C		
Renow	Time (min to max) (t _L)	60 – 150 seconds		
Peak Temp	260°C			
Time within	20 – 40 seconds			
Ramp-dow	6°C/second max			
Time 25°C t	8 minutes max.			
Do not exce	260°C			



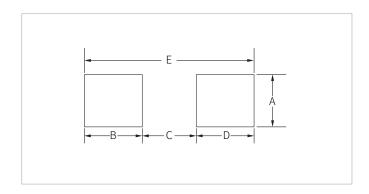
DO-214AA(SMB) PACKAGE INFORMATION



Ref.	MILLIIT	ieters	inches			
itel.	Min.	Max.	Min.	Max.		
А	1.80	2.20	0.071	0.087		
В	4.30	4.70	0.170	0.185		
С	3.40	3.90	0.134	0.153		
D	2.15	2.75	0.085	0.108		
Е	1.00	1.50	0.039	0.059		
F	0.02	0.20	0.001	0.008		
G	5.10	5.50	0.200	0.216		
Н	0.15	0.30	0.006	0.012		



RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millim	neters	Inches		
Kei.	Min.	Max.	Min.	Max.	
А	2.20	-	0.087	-	
В	1.45	-	0.057	-	
С	-	2.55	-	0.010	
D	1.45	-	0.057	-	
Е	5.60REF		0.22	0REF	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
GS5AB-GS5MB	DO-214AA(SMB)	3000PCS	13"



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By QR Code





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Machat

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